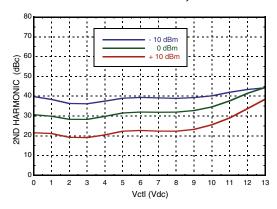


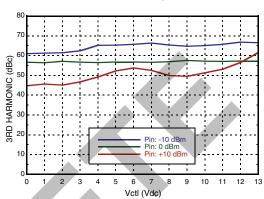


# 400° ANALOG PHASE SHIFTER 1 - 2 GHz

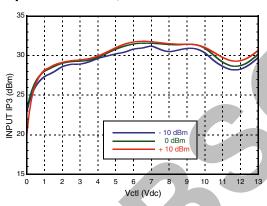
### Second Harmonic vs. Vctl, F = 1.5 GHz



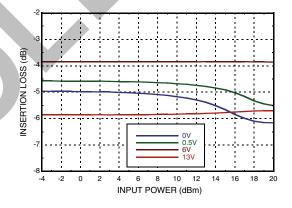
### Third Harmonic vs. Vctl, F = 1.5 GHz



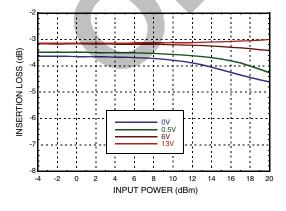
### Input IP3 vs. Vctl, F = 1.5 GHz



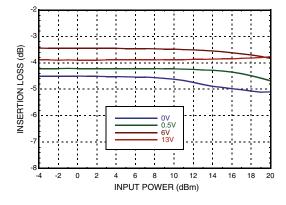
Insertion Loss vs. Pin @ 1 GHz



### Insertion Loss vs. Pin @ 1.5 GHz



### Insertion Loss vs. Pin @ 2 GHz



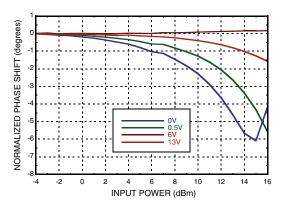


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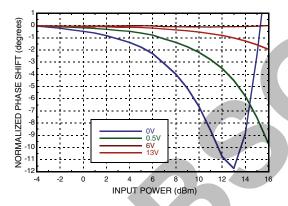


# 400° ANALOG PHASE SHIFTER 1 - 2 GHz

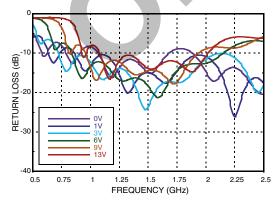
#### Phase Shift vs. Pin @ 1 GHz



### Phase Shift vs. Pin @ 2 GHz

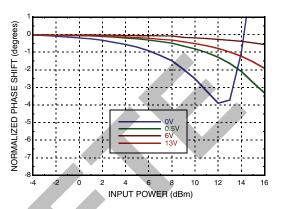


## Output Return Loss vs. Frequency, Vctl = 0 to +13V

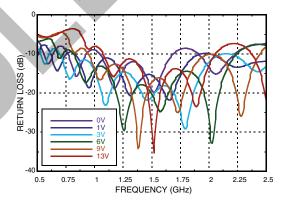




#### Phase Shift vs. Pin @ 1.5 GHz



## Input Return Loss vs. Frequency, Vctl = 0 to +13V



## **Absolute Maximum Ratings**

| Frequency Control Voltage (Vctl) | -0.5 to +15V   |  |
|----------------------------------|----------------|--|
| RF Input Power                   | 27 dBm         |  |
| Storage Temperature              | -65 to +150 °C |  |
| ESD Sensitivity (HBM)            | Class 1B       |  |

### Reliability Information

| Junction Temperature To Maintain 1 Million Hour MTTF         | 150 °C        |
|--|---------------|
| Nominal Junction Temperature<br>(T = 85 °C and Pin = 10 dBm) | 87 °C         |
| Thermal Resistance<br>(Junction To Ground Paddle)            | 45 °C/W       |
| Operating Temperature  | -40 to +85 °C |

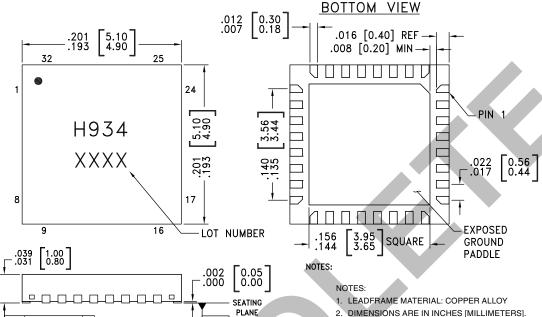
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# 400° ANALOG PHASE SHIFTER 1 - 2 GHz



## **Outline Drawing**

ANALOG DEVICES



- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- 3. DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15 mm PER SIDE.
- 4. DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25 mm PER SIDE.
- 5. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.
- 6. CLASSIFIED AS MOISTURE SENSITIVITY LEVEL (MSL) 1.

# Package Information

.003[0.08] C

| Part Number | Package Body Material                              | Lead Finish   | MSL Rating | Package Marking [1] |
|-------------|--|---------------|------------|---------------------|
| HMC934LP5E  | RoHS-Compliant Low Stress Injection Molded Plastic | 100% Matte Sn | MSL1 [2]   | H934<br>XXXX        |

<sup>[1] 4-</sup>Digit lot number XXXX

### **Pin Descriptions**

| Pin Number                         | Function | Description   | Interface Schematic          |
|------------------------------------|----------|---|------------------------------|
| 1 - 5, 8 - 13,<br>15 - 17, 20 - 32 | N/C      | No connection required. These pins may be connected to RF/DC ground without affecting performance.  |                              |
| 7, 18                              | GND      | Ground: Backside of package has exposed metal ground paddle that must be connected to ground thru a short path. Vias under the device are required.                                   | GND                          |
| 6                                  | RFIN     | This pin is AC coupled and matched to 50 Ohms.  | RFIN -                       |
| 19                                 | RFOUT    | This pin is AC coupled and matched to 50 Ohms.  | RFOUT                        |
| 14                                 | Vctl     | Phase shift control pin. Application of a voltage between 0 and 13 volts causes the transmission phase to change. The DC equivalent circuit is a series connected diode and resistor. | Vctl 100nH 30000<br>18pF83pF |

<sup>[2]</sup> Max peak reflow temperature of 260  $^{\circ}\text{C}$ 

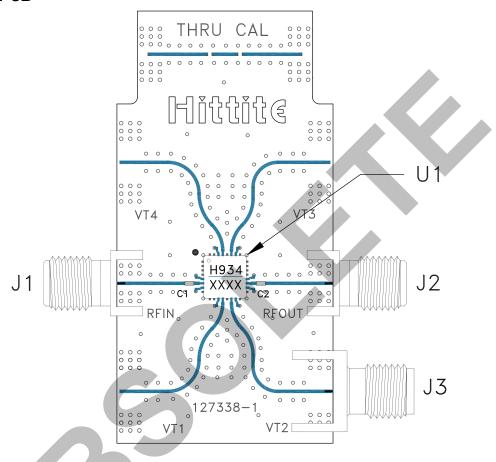


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## 400° ANALOG PHASE SHIFTER 1 - 2 GHz

#### **Evaluation PCB**



### List of Materials for Evaluation PCB 131046 [1]

| Item   | Description                     |
|--------|---------------------------------|
| J1, J2 | Connector, SMA, Jack            |
| J3     | Connector, SMA, Jack            |
| U1     | HMC934LP5E Analog Phase Shifter |
| C1, C2 | Capacitor, 100 pF, 0402 Pkg.    |
| РСВ    | 127338, Evaluation PCB          |

<sup>[1]</sup> Reference this number when ordering complete evaluation PCB

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

<sup>[2]</sup> Circuit Board Material: Rogers 4350 or Arlon 25 FR